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Dipole with an unbalanced microstrip feed

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Jenn

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(54) **DIPOLE WITH AN UNBALANCED MICROSTRIP FEED**

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(22) Filed: **Feb. 6, 2013**

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(51) **Int. Cl.**
H01Q 9/16 (2006.01)

(52) **U.S. Cl.**
CPC **H01Q 9/16** (2013.01)
USPC **343/793**

(58) **Field of Classification Search**
CPC H01Q 9/16
USPC 343/793, 795, 820, 821, 822
See application file for complete search history.

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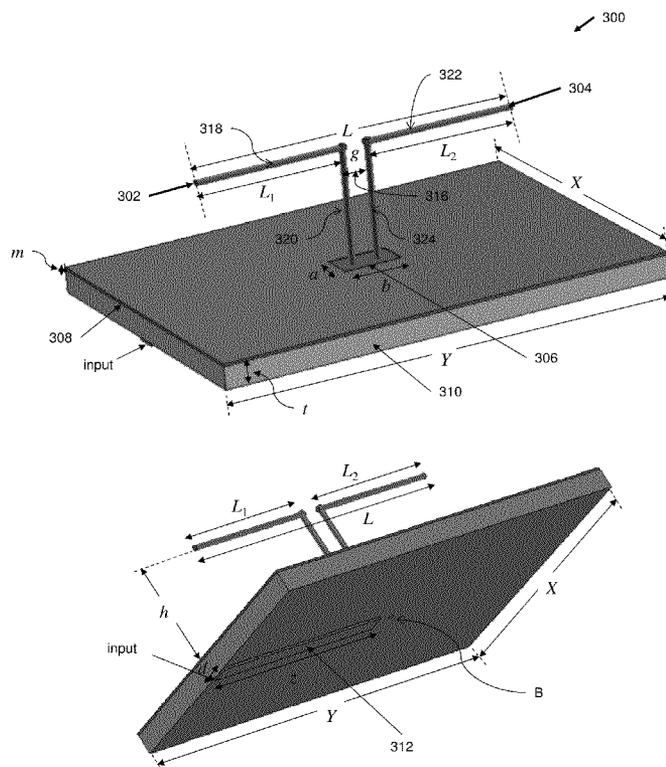
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(57) **ABSTRACT**

Embodiments in accordance with the invention include a linearly polarized dipole antenna with an unbalanced microstrip feed line. More specifically, embodiments in accordance with the invention utilize a fed dipole connected to a microstrip feed line, and separated a gap distance from a parasitic dipole not connected to the microstrip feed line. When an electrical signal is input to the microstrip feed line, the microstrip feed line creates a current flow in the fed dipole which induces a nearly equal current on the parasitic dipole that is out of phase. The result is a current flow, I, in the same direction in both fed and parasitic dipoles allowing for efficient radiation of the linearly polarized dipole antenna. Embodiments in accordance with the invention eliminate the need for a balun circuit thereby reducing the size, complexity and feed loss of the feed circuit. Embodiments in accordance with the invention are effective for dipoles with relatively small ground planes.

11 Claims, 10 Drawing Sheets



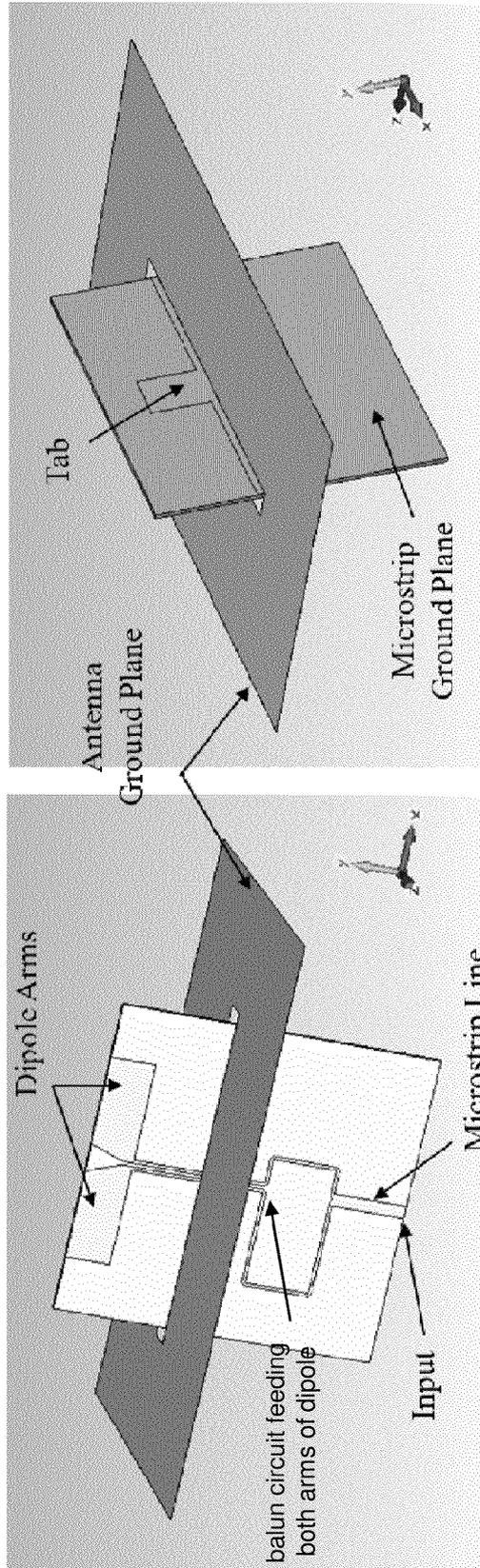


FIG. 1B
(Prior Art)

FIG. 1A
(Prior Art)

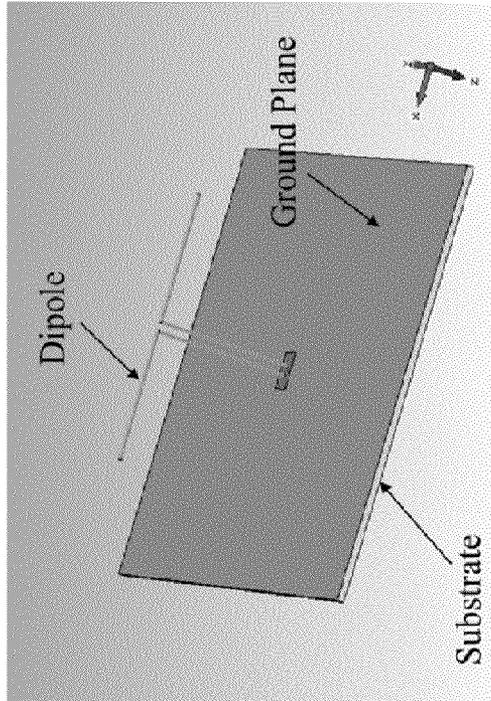


FIG. 2B
(Prior Art)

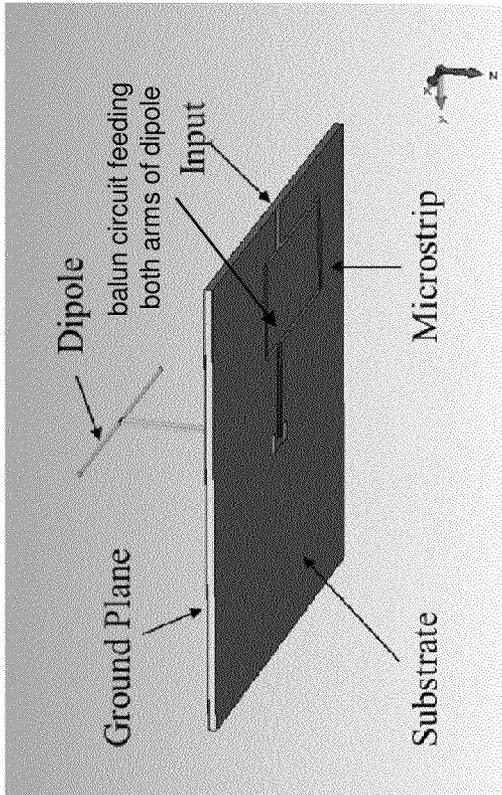


FIG. 2A
(Prior Art)

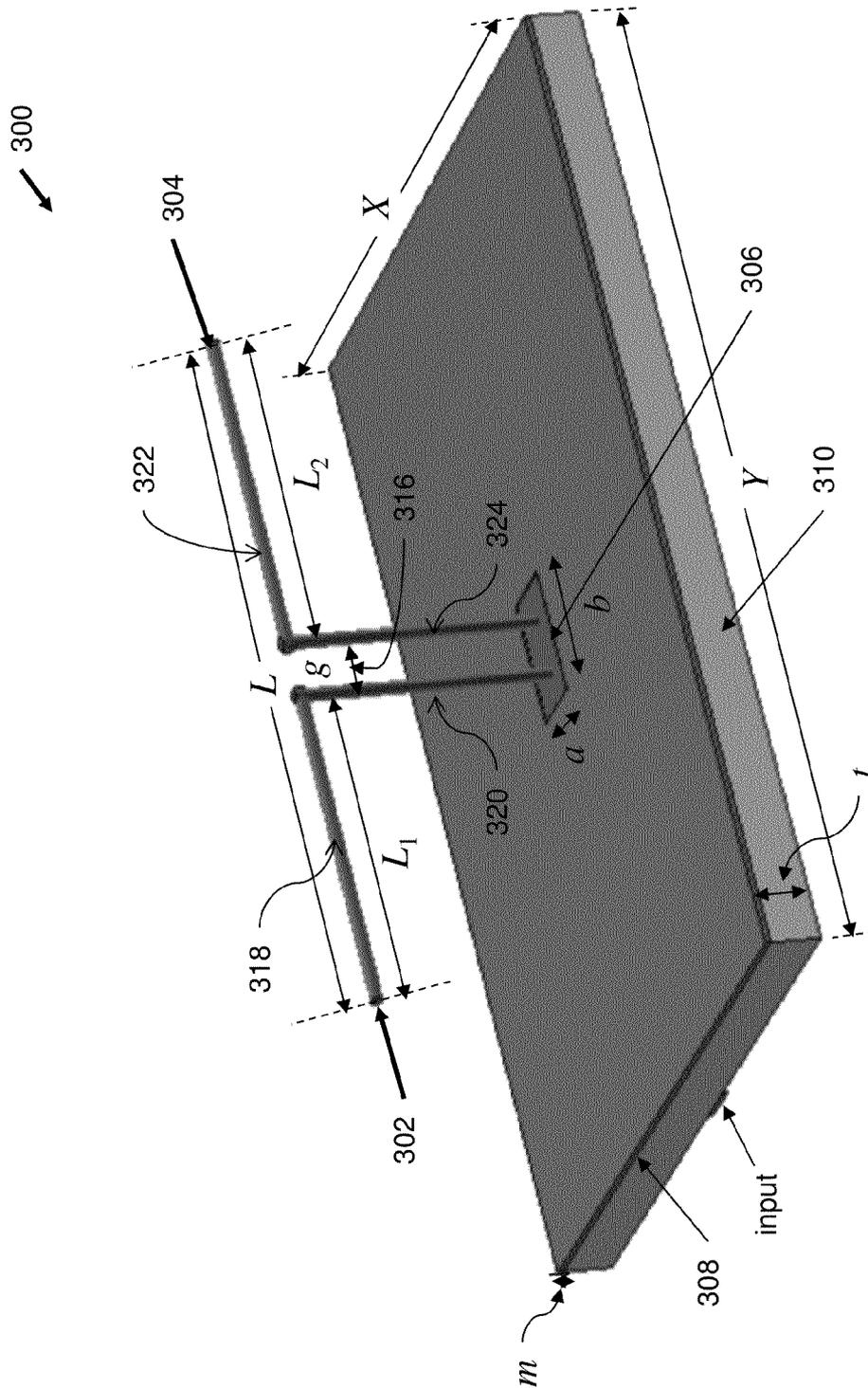


FIG. 3A

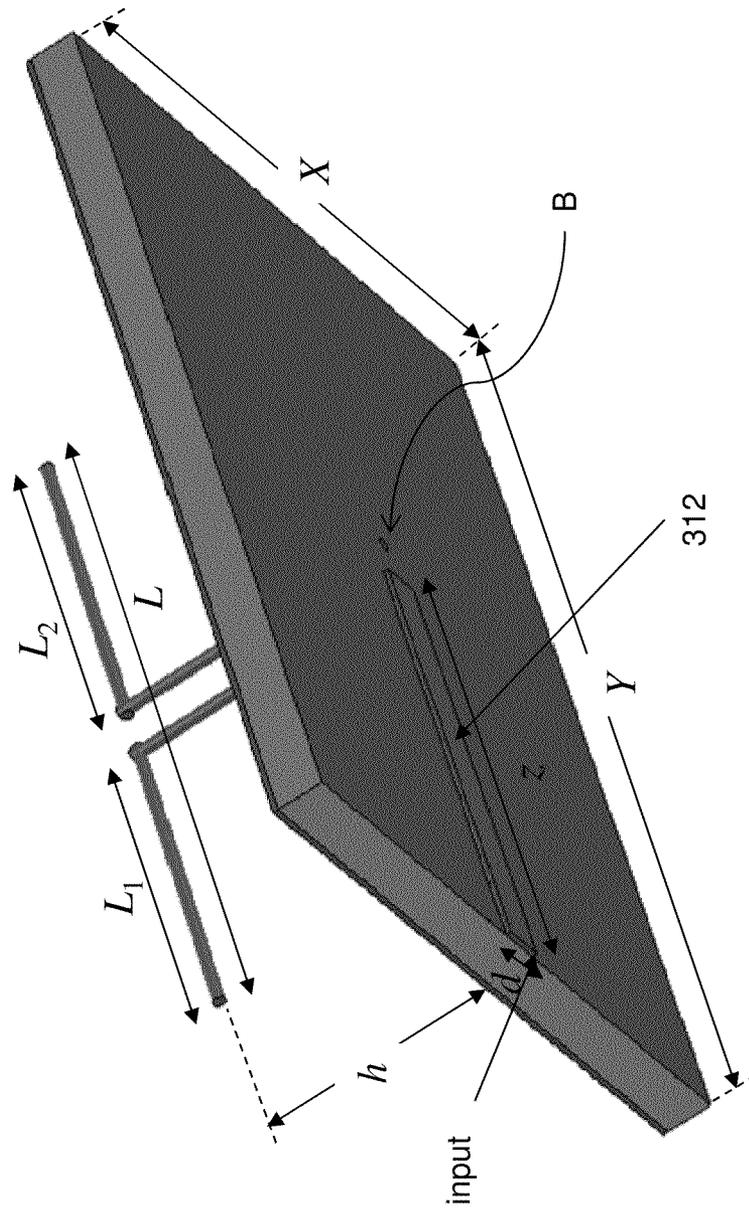


FIG. 3B

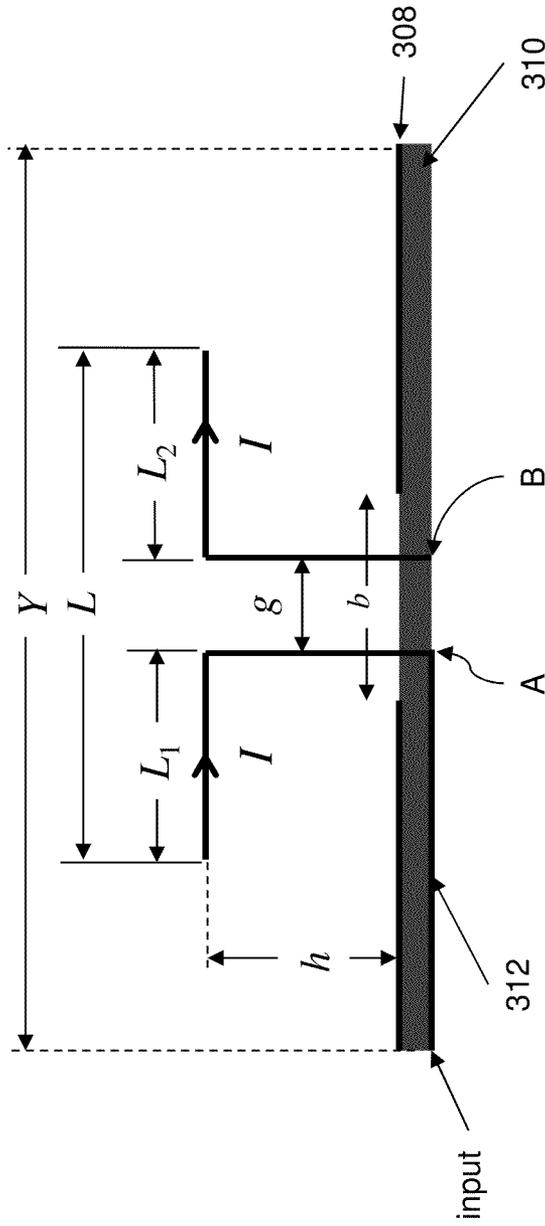


FIG. 3C

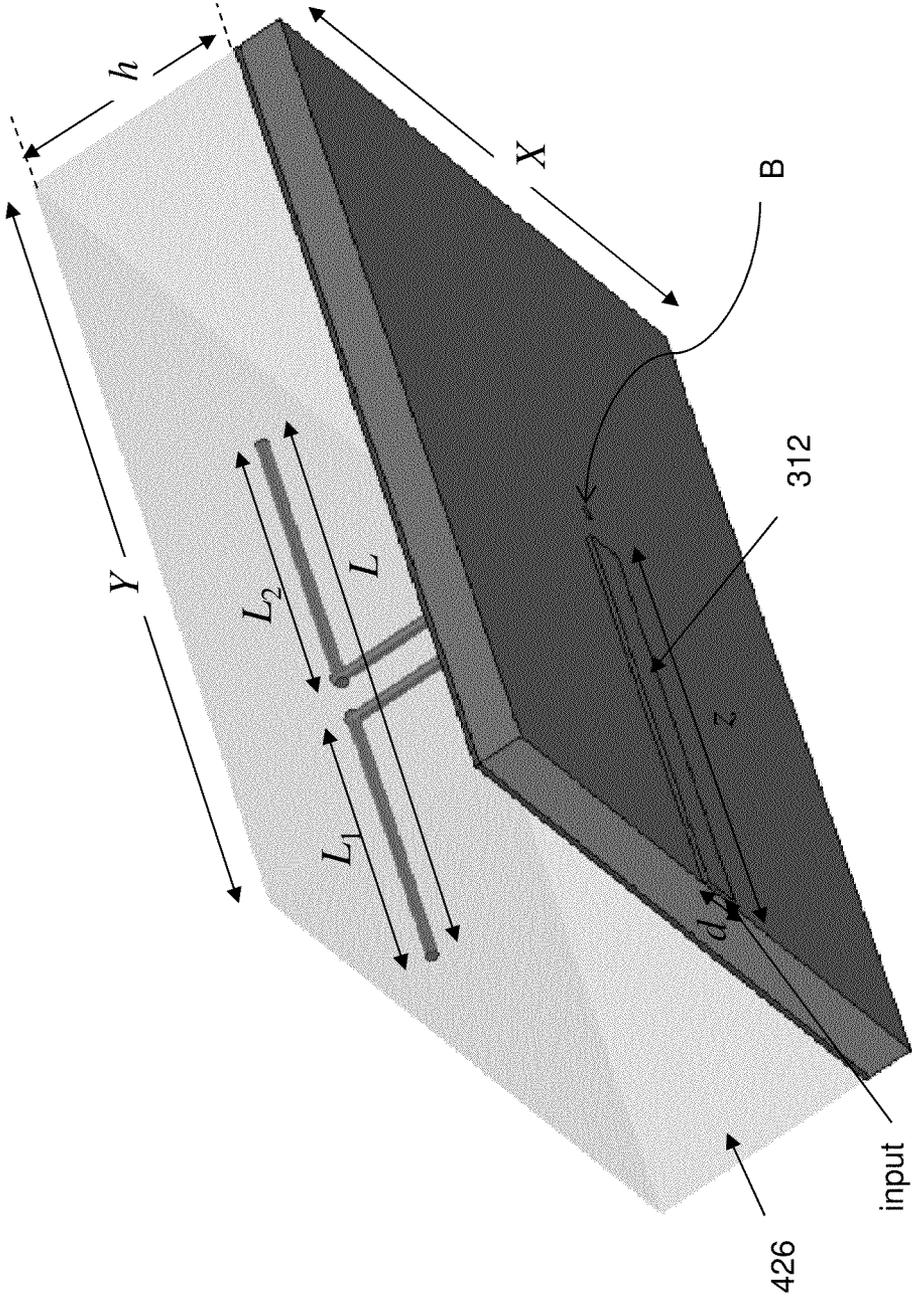


FIG. 4B

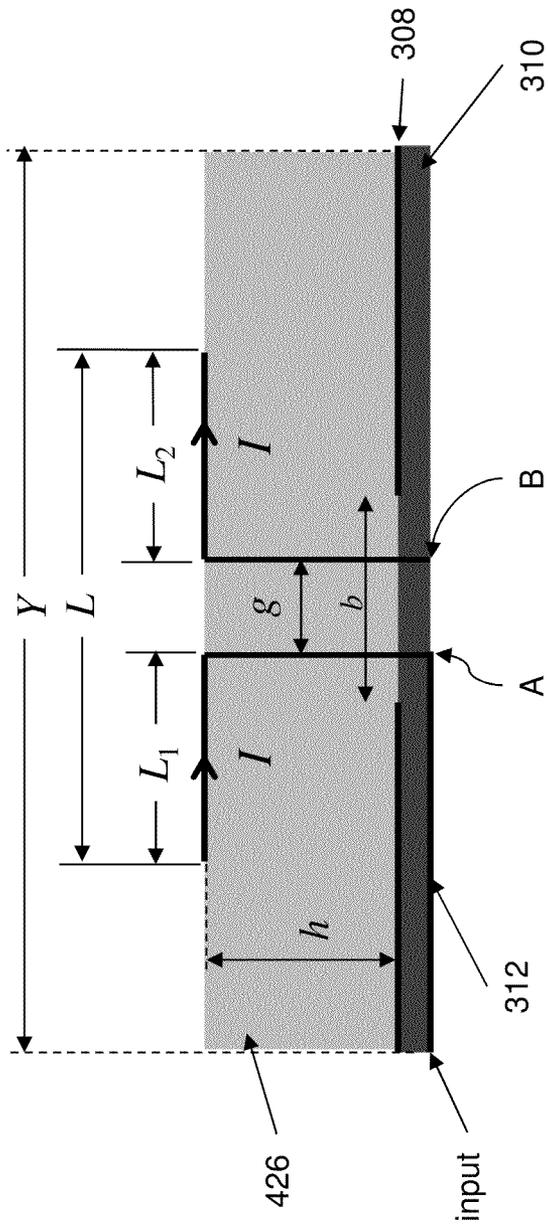


FIG. 4C

500

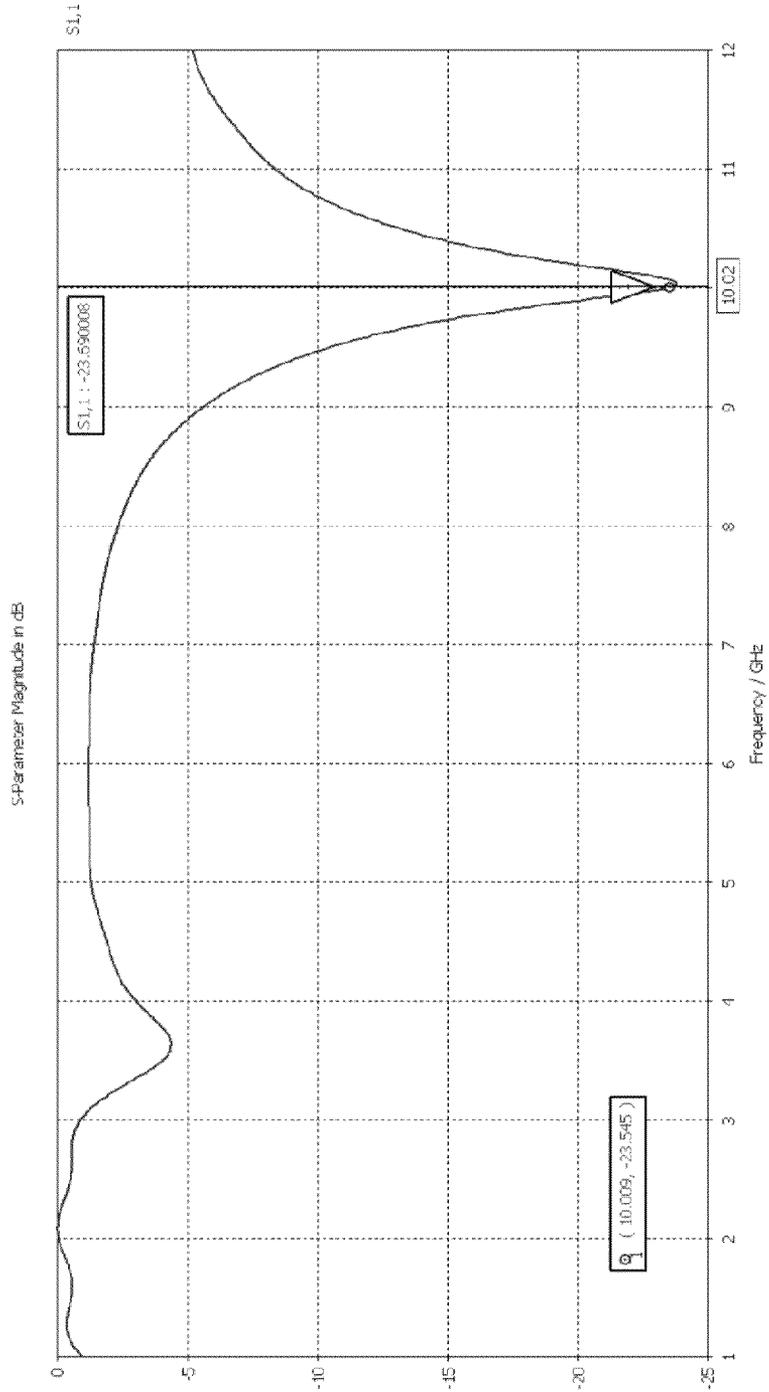


FIG. 5

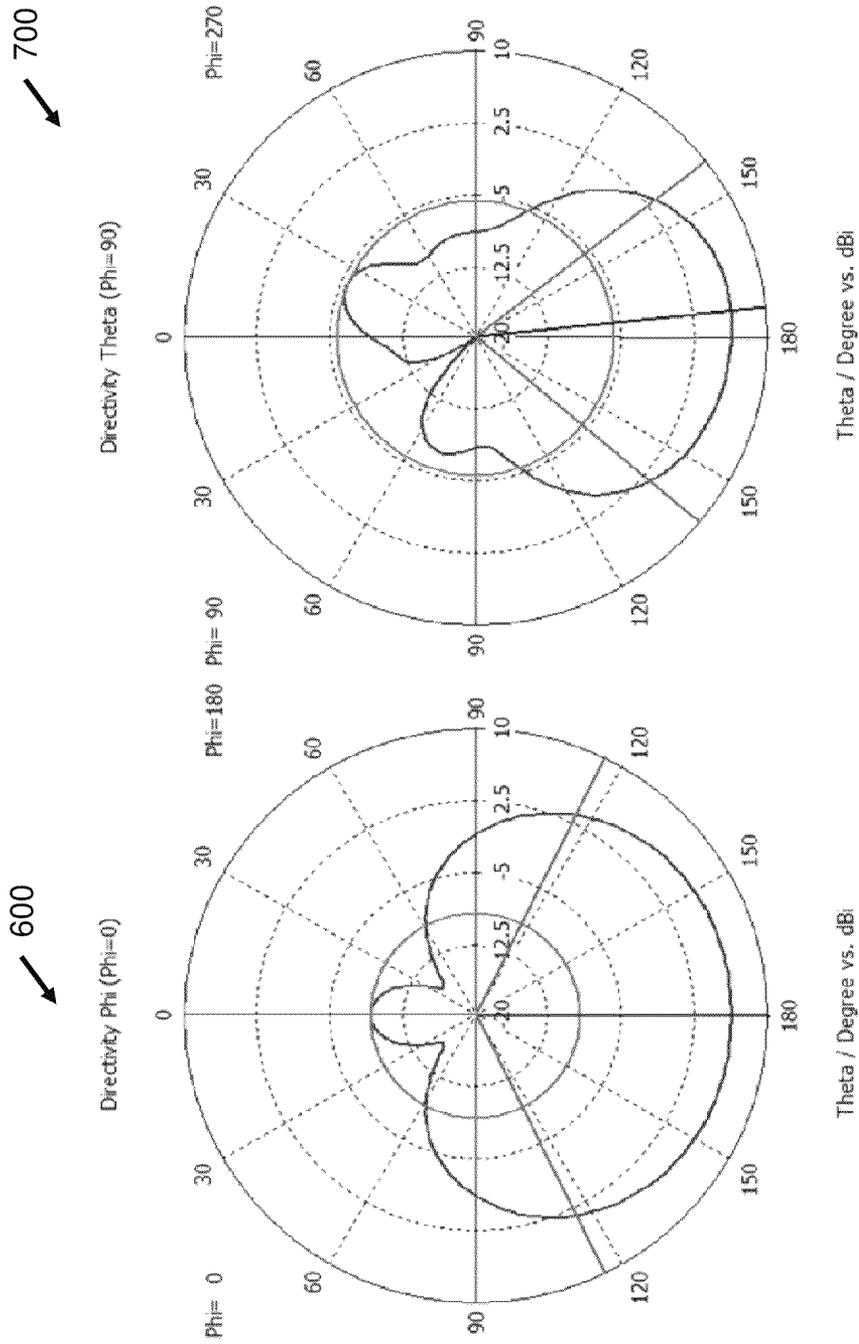


FIG. 7

FIG. 6

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DIPOLE WITH AN UNBALANCED MICROSTRIP FEED

CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims the benefit of U.S. Provisional Application No. 61/599,308 filed Feb. 15, 2012, which is hereby incorporated in its entirety by reference.

BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention relates generally to dipole antennas.

2. Description of the Related Art

Linearly polarized dipole antennas are commonly used in communication and radar applications. Dipoles can be used individually or as elements in an array antenna. Often a dipole antenna is fed using a microstrip feed line. Microstrip feed lines are utilized in many applications because the devices connected to the dipole are often printed on microstrip boards.

Prior art dipole structures utilized a balanced structure that generally required a balanced-to-unbalanced circuit, also termed a balun circuit, or simply a balun, when fed by a microstrip line. Depending on how the balun circuit was implemented, it had the undesired effect of increasing either the depth or area of the assembly. FIGS. 1A/1B and 2A/2B show instances of prior art dipole antennas utilizing balun circuits. In FIGS. 1A/1B and 2A/2B, the balun circuit is used to split a single input line into a two wire line for connecting to the dipole antenna. FIGS. 1A/1B illustrate how the prior art vertical implementation of a balun circuit increased the depth of the assembly by utilizing area on the vertical ground plane of the assembly. FIGS. 2A/2B illustrate how the prior art horizontal implementation of the balun circuit increased the area of the assembly by utilizing area on the horizontal ground plane of the assembly.

SUMMARY OF THE INVENTION

Embodiments in accordance with the invention include a linearly polarized dipole antenna with an unbalanced microstrip feed line which eliminate the need for a balun circuit thereby reducing the size, complexity and feed loss of the feed circuit. Embodiments in accordance with the invention are effective for dipoles with relatively small ground planes. In accordance with one embodiment, a linearly polarized dipole antenna with an unbalanced microstrip feed including: a substrate having a top surface and a back surface; a microstrip feed line in contact with the back surface of said substrate, the microstrip feed line having an input end for accepting an electrical signal; a ground plane having a top surface and a back surface, wherein the back surface of said ground plane is in contact with at least a portion of the top surface of the substrate, the ground plane further having a ground plane aperture in the top surface of the ground plane that exposes at least a portion of the substrate; a first conductive element having a first vertical stem and a first horizontal arm, wherein a first end of the first conductive element extends through said ground plane aperture through the substrate and contacts the microstrip feed line; and a second conductive element having a second vertical stem and a second horizontal arm, wherein the second vertical stem is spaced a gap distance, *g*, apart from the first vertical stem, and further wherein a first end of the second conductive element extends through the ground

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plane aperture through the substrate and is connected to the back surface of said substrate.

Embodiments in accordance with the invention are best understood by reference to the following detailed description when read in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1A illustrates a front side view of a prior art vertical implementation of a balun circuit.

FIG. 1B illustrates a back side view of a prior art vertical implementation of a balun circuit.

FIG. 2A illustrates a bottom side view of a prior art horizontal implementation of a balun circuit.

FIG. 2B illustrates a top side view of a prior art horizontal implementation of a balun circuit.

FIG. 3A illustrates a transverse top view of a linearly polarized dipole assembly with unbalanced microstrip feed in accordance with one embodiment.

FIG. 3B illustrates a transverse bottom view of the linearly polarized dipole assembly of FIG. 3A in accordance with one embodiment.

FIG. 3C illustrates a cross-sectional side view of the linearly polarized dipole assembly of FIG. 3A in accordance with one embodiment.

FIG. 4A illustrates a transverse top view of a linearly polarized dipole assembly with unbalanced microstrip feed of FIG. 3A including a support medium in accordance with another embodiment.

FIG. 4B illustrates a transverse bottom view of the linearly polarized dipole assembly of FIG. 4A in accordance with another embodiment.

FIG. 4C illustrates a cross-sectional side view of the linearly polarized dipole assembly of FIG. 4A in accordance with another embodiment.

FIG. 5 illustrates a return loss plot (in dB) showing good match to a 50 ohm microstrip line at 10 GHz for a sample design of a dipole with unbalanced microstrip feed in accordance with one embodiment.

FIG. 6 illustrates an H-plane radiation pattern for the sample design in accordance with one embodiment.

FIG. 7 illustrates an E-plane radiation pattern for the sample design in accordance with one embodiment.

Embodiments in accordance with the invention are further described herein with reference to the drawings.

DETAILED DESCRIPTION OF THE INVENTION

FIGS. 3A and 3B and 3C illustrate a linearly polarized dipole antenna assembly with unbalanced microstrip feed line in accordance with one embodiment. FIG. 3A illustrates a transverse top view of a linearly polarized dipole assembly **300** with unbalanced microstrip feed line in accordance with one embodiment. FIG. 3B illustrates a transverse bottom view of the linearly polarized dipole assembly of FIG. 3A in accordance with one embodiment. FIG. 3C illustrates a side view of the linearly polarized dipole assembly of FIG. 3A in accordance with one embodiment.

Referring to FIGS. 3A, 3B, and 3C, in one embodiment, linearly polarized dipole antenna assembly **300** includes two elements: a conductive first dipole element **302**, and a conductive second dipole element **304**. In one embodiment, a first end of first dipole element **302** extends through a ground plane aperture **306** in a top surface of a ground plane **308** through a substrate **310** and is attached to a microstrip feed line **312** at a point A at a back surface of substrate **310**. A first end of second dipole element **304** extends through ground

plane aperture **306** through substrate **310** and is attached at a point B to the back surface of substrate **310**. This arrangement of first dipole element **302** and second dipole element **304** can also be generally described as a bent monopole with a parasitic element. The remaining portions of first dipole element **302** and second dipole element **304** extend above the top surface of ground plane **308**. In one embodiment, first dipole element **302** and second dipole element **304** are positioned apart from each other at a gap distance **316**, g.

In one embodiment, first dipole element **302** includes a first horizontal arm **318** of first length, L1, and a first vertical stem **320** of height, h, where height, h, is measured from the top surface of ground plane **308** to first horizontal arm **318**. Second dipole element **304** includes a second horizontal arm **322** of second length, L2, and a second vertical stem **324** of height, h. In one embodiment, first dipole element **302** is formed of a conductive material, such as a metal wire of radius, r, and second dipole element **304** is formed of a conductive material, such as a metal wire of radius, r. In one embodiment, first dipole element **302** and second dipole element **304** are formed of the same conductive material, such as a metal wire having the same radius, r. In one embodiment, the metal wire can be copper. In other embodiments, other conductive metals or combination of metals can be used, dependent upon the application. In alternate embodiments, first dipole element **302** and second dipole element **304**, can be formed of different conductive materials and/or have different radii, with resultant changes in radiation patterns.

In one embodiment, the overall length of the dipole assembly, L, is defined as $L1+L2+g$, i.e., the first length plus the second length plus the gap distance **316**. In one embodiment, the first length, L1, is equal to second length, L2, and each of L1 and L2 is equal to $L/2-g/2$, i.e., the overall length divided by two minus the gap distance, g, divided by two.

In one embodiment, a back surface of ground plane **308** is attached to, or formed on, a top surface of substrate **310**. Ground plane aperture **306** is formed in ground plane **308** exposing substrate **310** and allowing first dipole element **302** and second dipole element **304** to be extended through the top surface of substrate **310** to the back surface of substrate **310**. On the back surface of substrate **310**, a first end of first element **302** is attached to microstrip feed line **312** at a point A. Microstrip feed line **312** is formed on, or attached to, the back surface of substrate **310**. A first end of second element **304** is attached to the back surface of substrate **310** at a point B, but second element **304** is not connected to microstrip feed line **312**.

In one embodiment, ground plane **308** is formed of a conductive metal and has a thickness, m. In one embodiment, the conductive metal can be copper. In other embodiments, other conductive metals or combination of metals can be used, dependent upon the application. In one embodiment, ground plane **308** serves as the ground plane for the dipole assembly, i.e., first dipole element **302** and second dipole element **304**, as well as the ground plane for microstrip feed line **312**. In one embodiment ground plane **308** has dimensions width, X, by length, Y. In various embodiments, the dimensions X and Y of ground plane **308** can be varied, depending on the requirements of the application. In one embodiment, substrate **310** is formed of a dielectric material of thickness, t, and relative dielectric constant, E. In one embodiment, microstrip feed line **312** is formed having a line width, d, and length, z.

As described above, first dipole element **302** is attached to a first end of microstrip feed line **312** at a point A. A second end of micro strip feed line **312**, also termed the input end of microstrip feed line **312**, is available for input of an electrical signal from a signal source (not shown) and powering of

dipole assembly **300**. The signal source can be attached to microstrip feed line **312**, or other devices and circuit elements can be mounted directly on microstrip feed line **312**.

In an alternate embodiment, a support medium is placed on the top surface of ground plane **308** through which first vertical stem **320** and second vertical stem **324** extend allowing first horizontal arm **318** and second horizontal arm **322** to rest on a top surface of the support medium. In this way the support medium provides structural support and protection to first dipole element **302** and second dipole element **304**.

FIGS. 4A and 4B and 4C illustrate a linearly polarized dipole antenna assembly **400** with an unbalanced microstrip feed including a support medium **426** in accordance with another embodiment. FIG. 4A illustrates a transverse top view of a linearly polarized dipole assembly with unbalanced microstrip feed of FIG. 3A including a support medium **426** in accordance with another embodiment. FIG. 4B illustrates a transverse bottom view of the linearly polarized dipole assembly of FIG. 4A in accordance with another embodiment. FIG. 4C illustrates a cross-sectional side view of the linearly polarized dipole assembly of FIG. 4A in accordance with another embodiment.

In one embodiment, support medium **426** is placed on the top surface of ground plane **308** through which first vertical stem **320** and second vertical stem **324** extend allowing first horizontal arm **318** and second horizontal arm **322** to rest on a top surface of support medium **426**. In this way support medium **426** provides structural support and protection to first dipole element **302** and second dipole element **304**. In some embodiments, support medium **426** is a foam block spacer of thickness, h, which is placed over the top surface of ground plane **308**. In other embodiments, different materials can be utilized for support medium **426**.

When a signal source (not shown) is connected to microstrip feed line **312**, due to the small gap distance **316**, g, current flows in first dipole element **302** and induces a nearly equal current on the open arm of parasitic second dipole element **304** that is out of phase according to Lentz's law. The result is a current flow, I, in the same direction in first dipole element **302** and second dipole element **304**, allowing for efficient radiation. The resulting radiation pattern is nearly identical to that of a conventionally fed dipole for small ground plane sizes.

As the size of ground plane **308** becomes larger, the radiation pattern becomes more asymmetrical, which is undesirable for many applications. This occurs because currents induced on ground plane **308** and first vertical stem **318** of first dipole element **302** are not equal to those induced on parasitic second dipole element **304**. However, the impedance match is relatively unaffected by the size of ground plane **308** and in many applications the variation in the gain inside of the half power beam widths, i.e., gain ripple, is not a problem as long as the gain is above a specified minimum value.

In one embodiment, the physical dimensions of the dipole, i.e., first dipole element **302** and second dipole element **304**, and ground plane **308** are selected so that first dipole element **302** and second dipole element **304** are "tuned" (resonant) and the impedance is matched to that of microstrip feed line **312**, for example, in one embodiment, 50 ohms. The tuning can be achieved using standard antenna design techniques and commercially available computer software. Parameters that can be adjusted include the dipole radius, r, dipole height above the ground plane, h, dipole length from end to end L, the area (a by b) of the ground plane aperture **306**, the dimensions, X by Y of ground plane **308**, and the distance of the gap distance **316**, g, between first dipole element **302** and second dipole element **304**. The thickness, t, of substrate **310**, the

width, d , of microstrip feed line **312**, and relative dielectric constant, ϵ_r , determine microstrip feed line **312** characteristic impedance. Widely available and well-known formulas exist for calculating the impedance as a function of these parameters.

Table 1 illustrates parameters of a sample design of a dipole assembly, such as shown in FIGS. **4A**, **4B**, and **4C** with an unbalanced microstrip feed in accordance with one embodiment.

TABLE 1

Parameter	Variable	Value
Dipole length	L	25 mm
Dipole radius	r	0.25 mm
Gap	g	1.5 mm
Dipole height	h	9 mm
Microstrip line width ($Z_0 = 50$)	d	1.6829 mm
Ground plane length in x	X	35 mm
Ground plane length in y	Y	35 mm
Ground plane aperture length in x	a	2.5 mm
Ground plane aperture length in y	b	3.5 mm
Substrate thickness	t	0.508 mm
Substrate relative dielectric constant	ϵ_{r_m}	1.96
Support medium thickness	h	9 mm
Support medium relative dielectric constant	ϵ_{r_s}	1.04

FIG. **5** illustrates a return loss plot **500** (in dB) showing good match to a 50 ohm microstrip line at 10 GHz for the sample design of Table 1. FIG. **6** illustrates an H-plane radiation pattern **600** for the sample design of Table 1. FIG. **7** illustrates an E-plane radiation pattern **700** for the sample design of Table 1.

As earlier discussed, when receiving an input signal, the resulting radiation pattern of dipole assembly **300/400** is nearly identical to that of a conventionally fed dipole for small ground plane sizes. As the size of ground plane **308** becomes larger, the radiation pattern becomes more asymmetrical, which is undesirable for most applications. This occurs because currents induced on ground plane **308** and first vertical stem **318** of first dipole element **302** are not equal to those induced on parasitic second dipole element **304**. In some embodiments, it is possible in some cases to restore the symmetry in the radiation pattern by introducing asymmetry into the geometry of the dipole assembly. In various embodiments, the height, h , or length, L_2 , of parasitic second dipole element **304**, can be made different than the height, or length, L_1 , of the fed first dipole element **302**.

Also, the length of ground plane **308** on the side on which first element **302** is located (relative to a center line of length, Y) can be made different from the length of ground plane **308** on the side on which second element **304** is located. In this embodiment, ground plane aperture **306** would not be centered at $Y/2$ on ground plane **308** and would be offset.

Embodiments in accordance with invention described herein can be made using conventional fabrication techniques. For example, substrate **310**, ground plane **308**, ground plane aperture **306**, and microstrip feed line **312** can be manufactured using conventional fabrication techniques, for example, conventional techniques of deposition, patterning, and/or etching. In some embodiments, some or all of the above elements can be separately manufactured using conventional fabrication techniques and then assembled. First dipole element **302** and second dipole element **302** can be fabricated using conventional dipole manufacturing techniques, such as manufacturing and shaping a selected wire having a selected radius, r . In various embodiments, vias can

be formed in substrate **310** to permit the first end of first dipole element **302** and the first end of second dipole element **304** to pass through substrate **310** and allow attachment at points A and B, respectively. In one embodiment, the vias can be formed mechanically, while in other embodiments, the vias can be formed using conventional fabrication techniques of deposition, patterning, and/or etching. In one embodiment support medium **426** can be a foam block as earlier described, which is shaped in accordance with the size parameters of ground plane **308** and height, h . During assembly support medium **426** is placed over ground plane **308** and first dipole element **302** and second dipole element **404** are inserted through support medium **426**, through ground plane aperture **306** and substrate **310** and attached respectively at points A and B.

Embodiments in accordance with the linearly polarized unbalanced microstrip fed dipole assembly described herein are simple, low loss and compact. Embodiments in accordance with the invention are easily integrated into micro strip structures. Embodiments in accordance with the invention have applicability as a "rectenna", also termed a rectifying antenna. Rectennas are used in converting microwave signals to direct current for wireless power and energy harvesting applications. Important civilian and military applications are for powering small UAVs, satellite station keeping, and wireless battery charging. Most prior art rectenna structures can only provide half wave rectification, however, embodiments in accordance with the invention can easily be extended to provide full-wave rectification with resultant efficiencies.

This disclosure provides exemplary embodiments of the present invention. The scope of the present invention is not limited by these exemplary embodiments. Numerous variations, whether explicitly provided for by the specification or implied by the specification or not, may be implemented by one of skill in the art in view of this disclosure.

What is claimed is:

1. A linearly polarized dipole antenna with an unbalanced microstrip feed comprising:

a substrate having a top surface and a back surface;
a microstrip feed line in contact with said back surface of said substrate, said microstrip feed line having an input end for accepting an electrical signal;

a ground plane having a top surface and a back surface, wherein said back surface of said ground plane is in contact with at least a portion of said top surface of said substrate, said ground plane further having a ground plane aperture in said top surface of said ground plane that exposes at least a portion of said substrate;

a conductive first dipole element having a first vertical stem and a first horizontal arm, wherein a first end of said first dipole element extends through said ground plane aperture through said substrate and contacts said microstrip feed line; and

a conductive second dipole element having a second vertical stem and a second horizontal arm, wherein said second vertical stem is spaced a gap distance, g , apart from said first vertical stem, and further wherein a first end of said second dipole element extends through said ground plane aperture through said substrate and is connected to said back surface of said substrate.

2. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim **1** wherein application of an input signal to said input end of said microstrip feed line creates current flow in said first dipole element and induces a nearly equal current on said second dipole element that is out of phase resulting in a current flow, I , in the same direction as in said first dipole element and producing radiation.

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- 3. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 further comprising: a support medium having a top surface and a back surface, wherein said back surface of said support medium is located above and in contact with said top surface of said ground plane, wherein said first vertical stem and said second vertical stem extend through said support medium to said ground plane aperture.
- 4. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 3 wherein said first horizontal arm and said second horizontal arm are in contact with said top surface of said support medium.
- 5. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein said first vertical stem and said second vertical stem are the same height, h, and wherein said first horizontal arm and said second horizontal arm are the same length, L.
- 6. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein said ground plane has a length of Y and a width of X.
- 7. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein said substrate has a thickness of t and a dielectric constant value of ϵ .

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- 8. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein when an electrical signal is input to said microstrip feed line, said antenna radiates.
- 9. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein when an electrical signal is input to said microstrip feed line, a current flow is created in said first dipole element which induces a nearly equal current on said second dipole element that is out of phase resulting in a current flow, I, in the same direction in both said first dipole element and said second dipole element.
- 10. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein said first vertical stem has a first height, h, and said second vertical stem has a second height, different from said first height.
- 11. The linearly polarized dipole antenna with an unbalanced microstrip feed of claim 1 wherein said first horizontal arm has first length, L1, and said second horizontal arm has a second length, L2, that is different from said first length, L1.

* * * * *